

### **Features**

- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)
- Advanced Trench MOSFET Process Technology
- · Epoxy Meets UL 94 V-0 Flammability Rating
- · Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

## **Maximum Ratings**

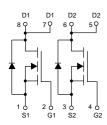
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 73.5°C/W Junction to Ambient(Note 2)

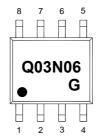
Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Volltage	$V_{GS}$	±20	٧
Drain Current	I <sub>D</sub>	3.0	Α
Pulsed Drain Current <sup>(Note3)</sup>	I <sub>DM</sub>	10	Α
Total Power Dissipation	$P_D$	1.7	W

### Note:

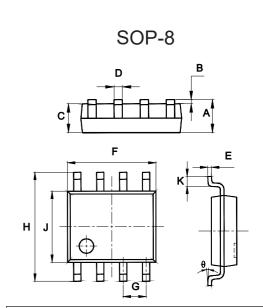
- 1.Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2.The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in2 FR-4 board with 2oz.
- 3.Pulse Test : Pulse Width≤300µs, Duty Cycle≤0.5%.

## **Internal Structure and Marking Code**



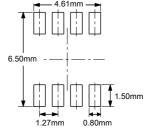


# Dual N-Channel Power MOSFET



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	NOIL
Α	0.053	0.069	1.35	1.75	
В	0.004	0.010	0.10	0.25	
С	0.053	0.061	1.35	1.55	
D	0.013	0.020	0.33	0.51	
Е	0.007	0.010	0.17	0.25	
F	0.185	0.200	4.70	5.10	
G	0.050		0.050 1.270		TYP.
Н	0.228	0.244	5.80	6.20	
J	0.150	0.157	3.80	4.00	
K	0.016	0.050	0.40	1.27	
θ	0°	8°	0°	8°	

## Suggested Solder Pad Layout



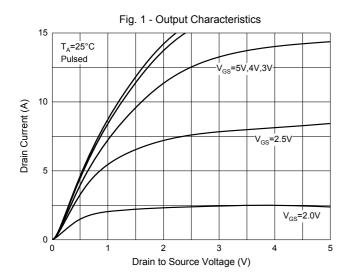


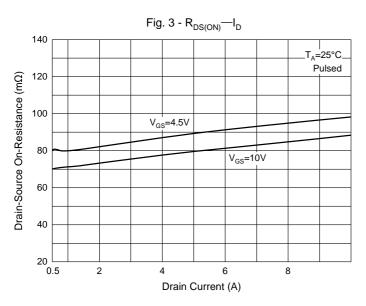
## Electrical Characteristics @ 25°C (Unless Otherwise Specified)

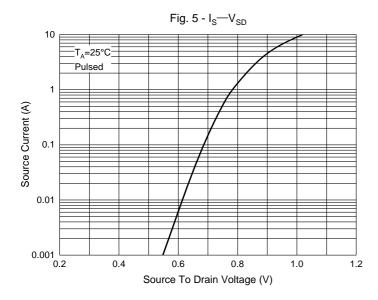
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60	65		V	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	μA	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	0.8	1.35	1.4	V	
Drain Cauras On Basistanas		V <sub>GS</sub> =10V, I <sub>D</sub> =3A		75	105		
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A		85	125	mΩ	
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =3A			1.2	V	
Forward Tranconductance	<b>9</b> FS	V <sub>DS</sub> =15V, I <sub>D</sub> =2A	1.4			S	
Diode Forward Current	Is				3.0	Α	
Dynamic Characteristics	'				,		
Input Capacitance	C <sub>iss</sub>			247		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =30V, $V_{GS}$ =0V,f=1MHz		34			
Reverse Transfer Capacitance	C <sub>rss</sub>			19.5			
Switching Characteristics	1			1			
Total Gate Charge	Q <sub>g</sub>			6			
Gate-Source Charge	$Q_{gs}$	$V_{DS}$ =30V, $V_{GS}$ =4.5V, $I_{D}$ =3A		1		nC	
Gate-Drain Charge	$Q_{gd}$			1.3			
Turn-On Delay Time	t <sub>d(on)</sub>			6			
Turn-On Rise Time	t <sub>r</sub>	V <sub>GS</sub> =10V,V <sub>DD</sub> =30V,I <sub>D</sub> =1.5A,		15			
Turn-Off Delay Time	$t_{d(off)}$	$R_{GEN}$ =1 $\Omega$		15		- ns	
Turn-Off Fall Time	t <sub>f</sub>			10			

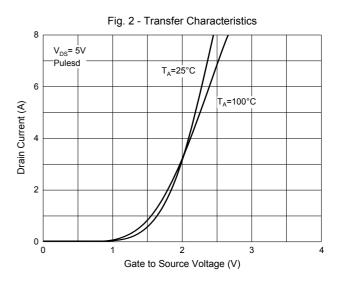


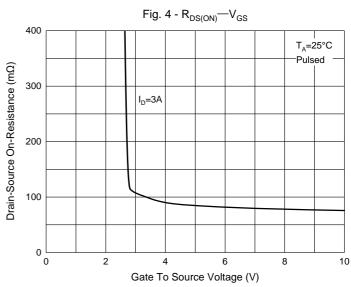
### **Curve Characteristics**

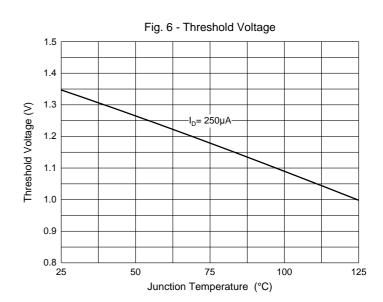














## **Ordering Information**

Device	Packing	
Part Number-TP	Tape&Reel: 4Kpcs/Reel	

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